



8x931AA/8x931HA UNIVERSAL SERIAL BUS PERIPHERAL CONTROLLERS

- **8x931AA Hubless USB Peripheral Controller**
- **On-chip USB Transceivers**
- **On-chip Phase-locked loop**
- **FIFO Data Buffers**
 - Two Pairs of 8-byte Transmit and Receive FIFOs
 - One Pair of 16-byte Transmit and Receive FIFOs
 - Supports Isochronous and Non-isochronous Data
- **Automatic FIFO Management**
- **Three USB Interrupt Vectors**
 - Endpoint Transmit/Receive Done
 - Start of Frame
 - Global Suspend/Resume/USB Reset
- **Regulated 3V Output for Root Port Pullup Resistor**
- **On-chip ROM Options**
 - 0 or 8 Kbytes
- **256 bytes On-chip Data RAM**
- **Four Input/Output Ports**
- **MCS[®] 51 UART**
- **Three 16-bit Timer/Counters**
- **Keyboard Control Interface**
- **Four Dedicated LED Driver Outputs**
- **6- or 12-MHz Crystal Operation**
 - Low Clock Mode (3MHz)
- **8x931HA Includes all 8x931AA Features**
- **8x931HA USB Hub has One Internal Downstream, and Four External Downstream Ports**
 - Universal Serial Bus Specification 1.0 Compliant
 - Serves as both USB Hub and USB Embedded Function (Internal Port)
- **USB Hub**
 - Connectivity Management
 - Downstream Device Connect/Disconnect Detection
 - Power Management, Including Suspend and Resume
 - Bus Fault Detection and Recovery
 - Full and Low Speed Downstream Device Support
- **Hub Endpoint Done Interrupt**
- **Output Pin for Port Power Switching**
- **Input Pin for Overcurrent Detection**
- **Hub FIFO Data Buffers**
 - One Pair of 8-byte Transmit and Receive FIFOs
 - One 1-byte Transmit Register
- **Embedded Function FIFO Data Buffers**
 - Same as the 8x931AA
- **12-MHz Crystal Operation**
 - Low Clock Mode (3MHz)

The 8x931AA and 8x931HA USB peripheral controllers are based on the MCS[®]51 microcontroller. They consist of standard 8XC51Fx peripherals plus a USB module. The 8x931HA USB module provides both USB hub and USB embedded function capabilities. The 8x931HA supports USB hub functionality, embedded function, suspend/resume modes, isochronous/non-isochronous transfers, and is USB rev 1.0 specification compliant. The USB module contains one internal and 4 external downstream ports and integrates the USB transceivers, serial bus interface engine (SIE), hub interface unit (HIU), function interface unit (FIU), and transmit/receive FIFOs. The 8x931AA is a hubless USB peripheral controller which contains the same feature set as the 8x931HA hub controller except for the hub module. The 8x931AA/HA uses the standard instruction set of the MCS 51 architecture.

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1.0 ABOUT THIS DOCUMENT

This data sheet contains advance information about Intel's 8x931AA and 8x931HA Universal Serial Bus peripheral controllers, based on the MCS@51 peripheral controller, which includes a functional overview, mechanical data, targeted electrical specifications (simulated), and bus functional waveforms. A detailed functional description, other than parametric performance, is published in the 8x931AA, 8x931HA Universal Serial Bus Peripheral Controller User's Manual (273102-001).

1.2 Electronic Information

We offer a variety of technical and product information through the World Wide Web (see Table 2 for URL) and through FaxBack service which is an on-demand publishing system that sends documents to your fax machine. You can get product announcements, change notifications, product literature, device characteristics, design recommendations, and quality and reliability information 24 hours a day, 7 days a week. Just dial the telephone number and respond to the system prompts.

1.1 Additional Information Sources

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Table 1. Related Documentation

Document Title	Order/Contact
<i>8x931AA, 8x931HA Universal Serial Bus Peripheral Controller User's Manual</i>	Intel Order #273102-001
<i>Universal Serial Bus Specification, Rev. 1.0</i>	Intel Order #272904

Table 2. Electronic Information

Document Title	Order/Contact
Intel's World-Wide Web (WWW) Location:	http://www.intel.com/design/usb/
Customer Support (US and Canada):	800-628-8686
FaxBack Service:	
<i>US and Canada</i>	800-628-2283
<i>Europe</i>	+44(0)793-496646
<i>worldwide</i>	916-356-3105
Application Bulletin Board Service:	
<i>up to 14.4-Kbaud line, worldwide</i>	916-356-3600
<i>dedicated 2400-baud line, worldwide</i>	916-356-7209
<i>Europe</i>	+44(0)793-496340

1.3 Product Summary

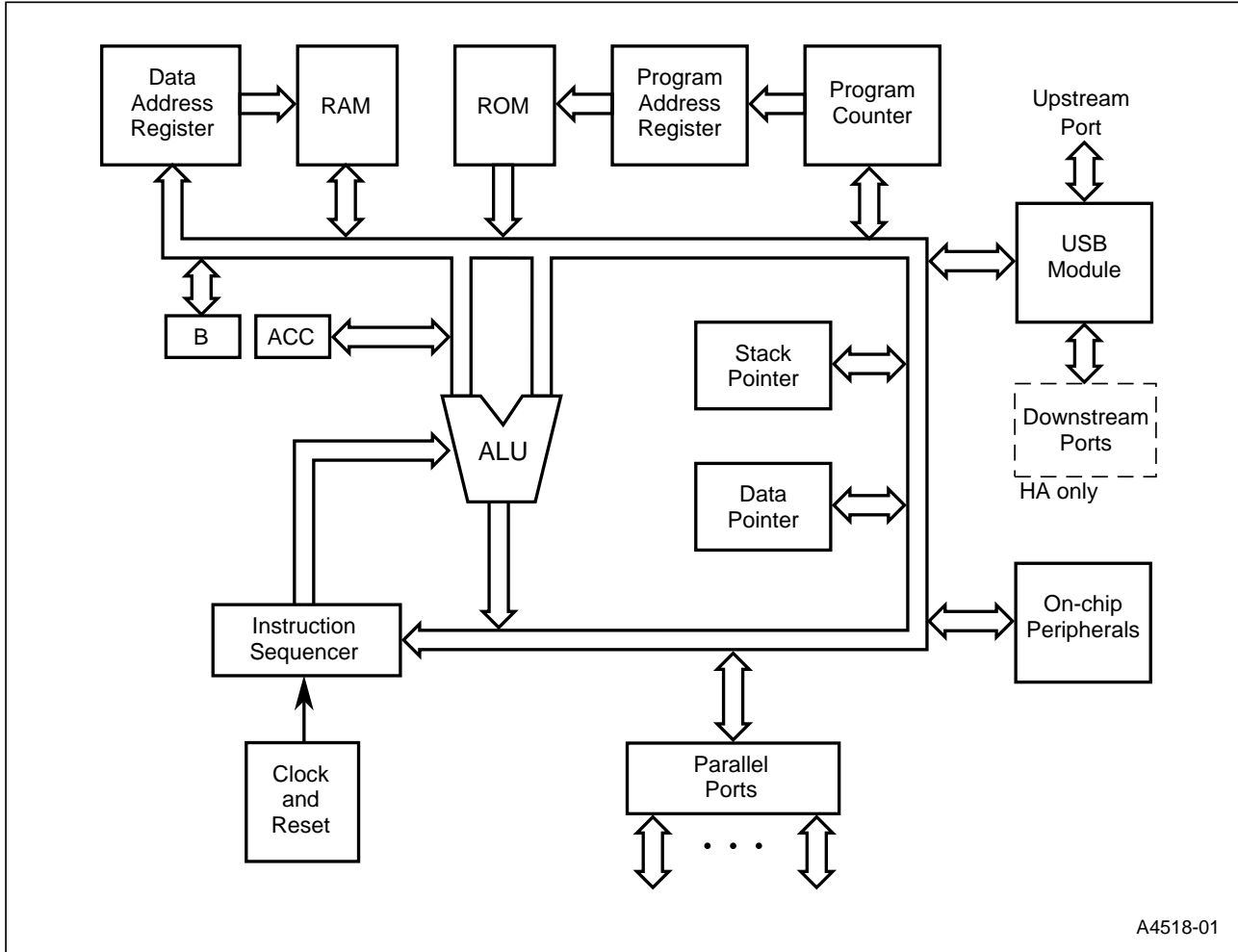


Figure 1. 8x931 Functional Block Diagram

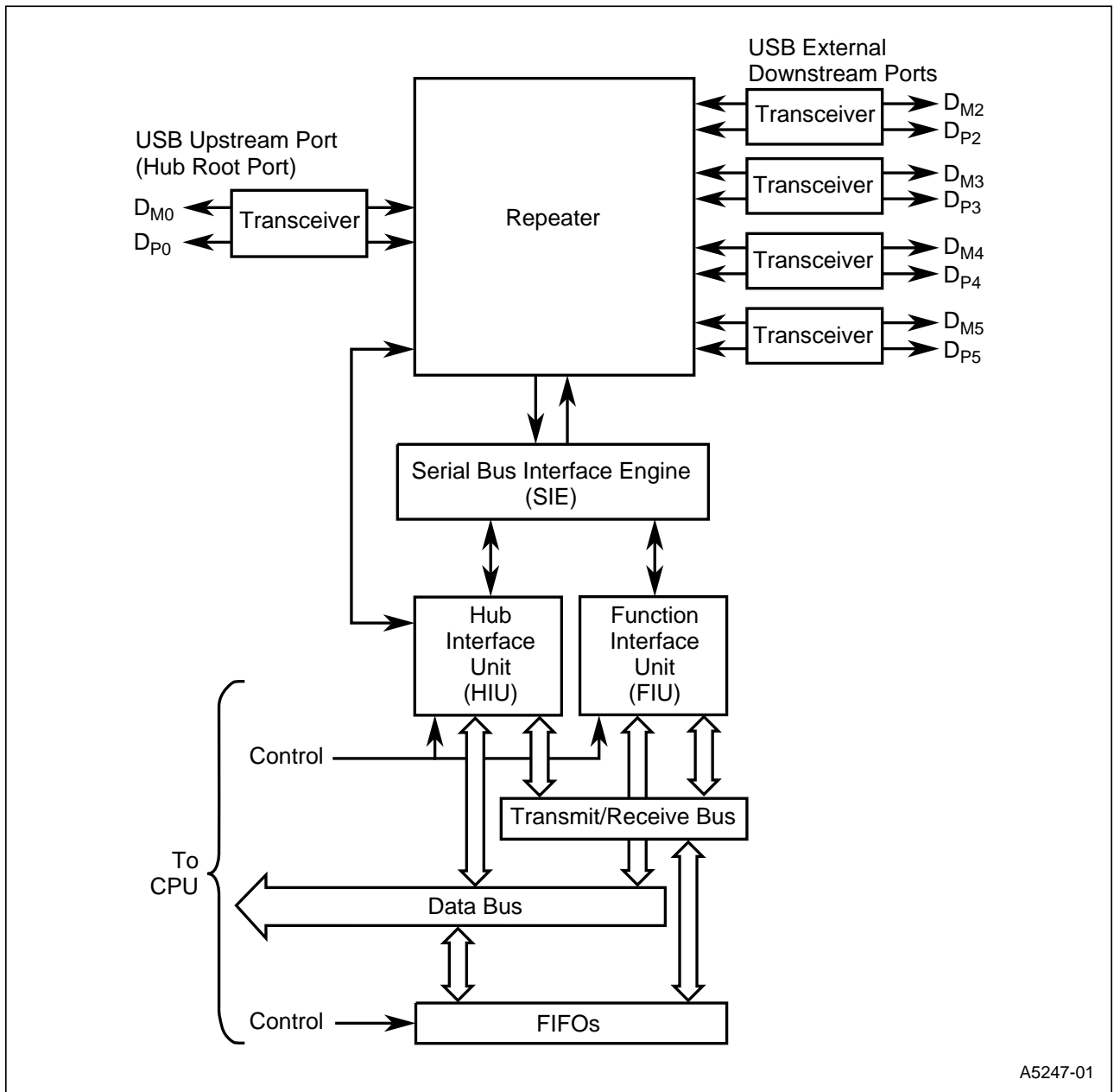


Figure 2. 8x931HA USB Module Block Diagram

2.0 NOMENCLATURE OVERVIEW

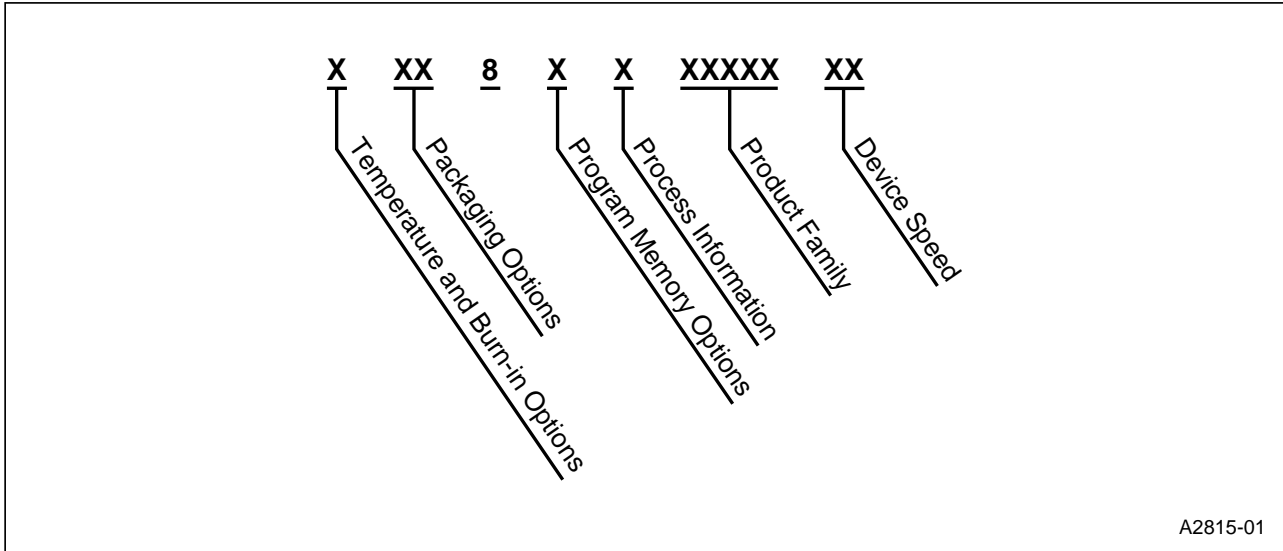


Figure 3. Product Nomenclature

Table 3. Description of Product Nomenclature

Parameter	Options	Description
Temperature and Burn-in	no mark	Commercial operating temperature range (0°C to 70°C) with Intel standard burn-in
Packaging Options	N	Plastic Leaded Chip Carrier (PLCC)
Program Memory Options	0	Without ROM
	3	With ROM
Process and Voltage Information	no mark	CHMOS
Product Family	931Hx	Advanced 8-bit microcontroller architecture with on-chip Universal Serial Bus Hub and Function capability. Indicates ROM size, RAM size, and quantity of external downstream ports (see Table 4).
	931Ax	Advanced 8-bit microcontroller architecture with on-chip Universal Serial Bus Function capability. Indicates ROM size, RAM size, and quantity of external downstream ports (see Table 5).
Device Speed	no mark	6 or 12 MHz crystal (8x931AA), 12MHz crystal (8x931HA)



Table 4. 8x931HA Proliferation Options

Part Name	ROM Size	RAM Size	Package
N80931HA	0	256 bytes	68-pin PLCC
N83931HA	8 Kbytes	256 bytes	68-pin PLCC

Table 5. 8x931AA Proliferation Options

Part Name	ROM Size	RAM Size	Package
N80931AA	0	256 bytes	68-pin PLCC
N83931AA	8 Kbytes	256 bytes	68-pin PLCC

8x931AA, 8x931HA USB PERIPHERAL CONTROLLER

3.0 PINOUT

3.0.1 8x931HA 68-pin PLCC Package

Figure 4 illustrates a diagram of the 8x931HA PLCC package. Table 6 and Table 7 contain indexes of the pin arrangement. Table 8 contains the signal descriptions for all pins.

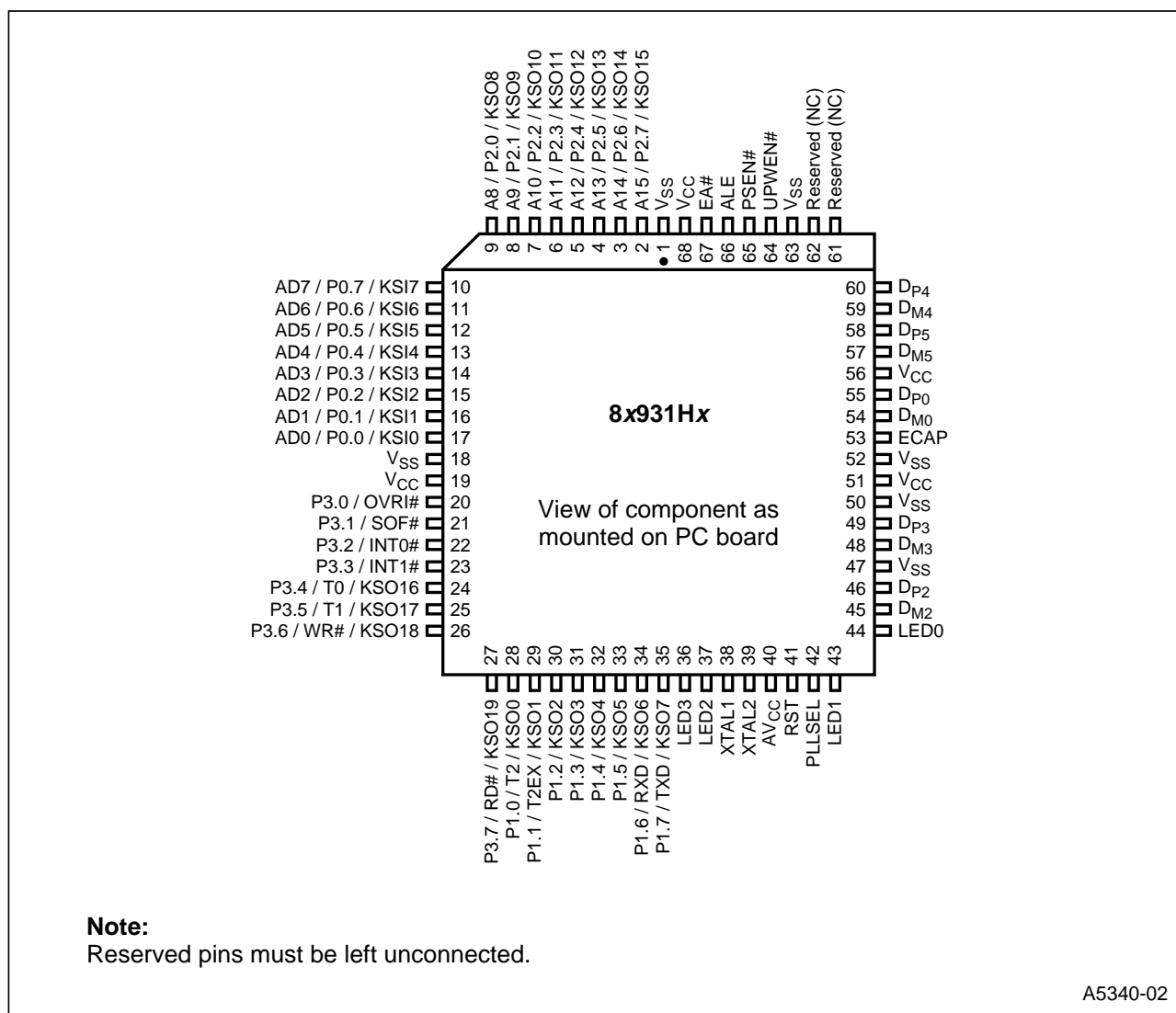


Figure 4. 8x931HA 68-pin PLCC Package

3.0.2 8x931AA 68-pin PLCC Package

Figure 5 illustrates a diagram of the 8x931AA PLCC package. Table 6 and Table 7 contain indexes of the pin arrangement. Table 8 contains the signal descriptions for all pins.

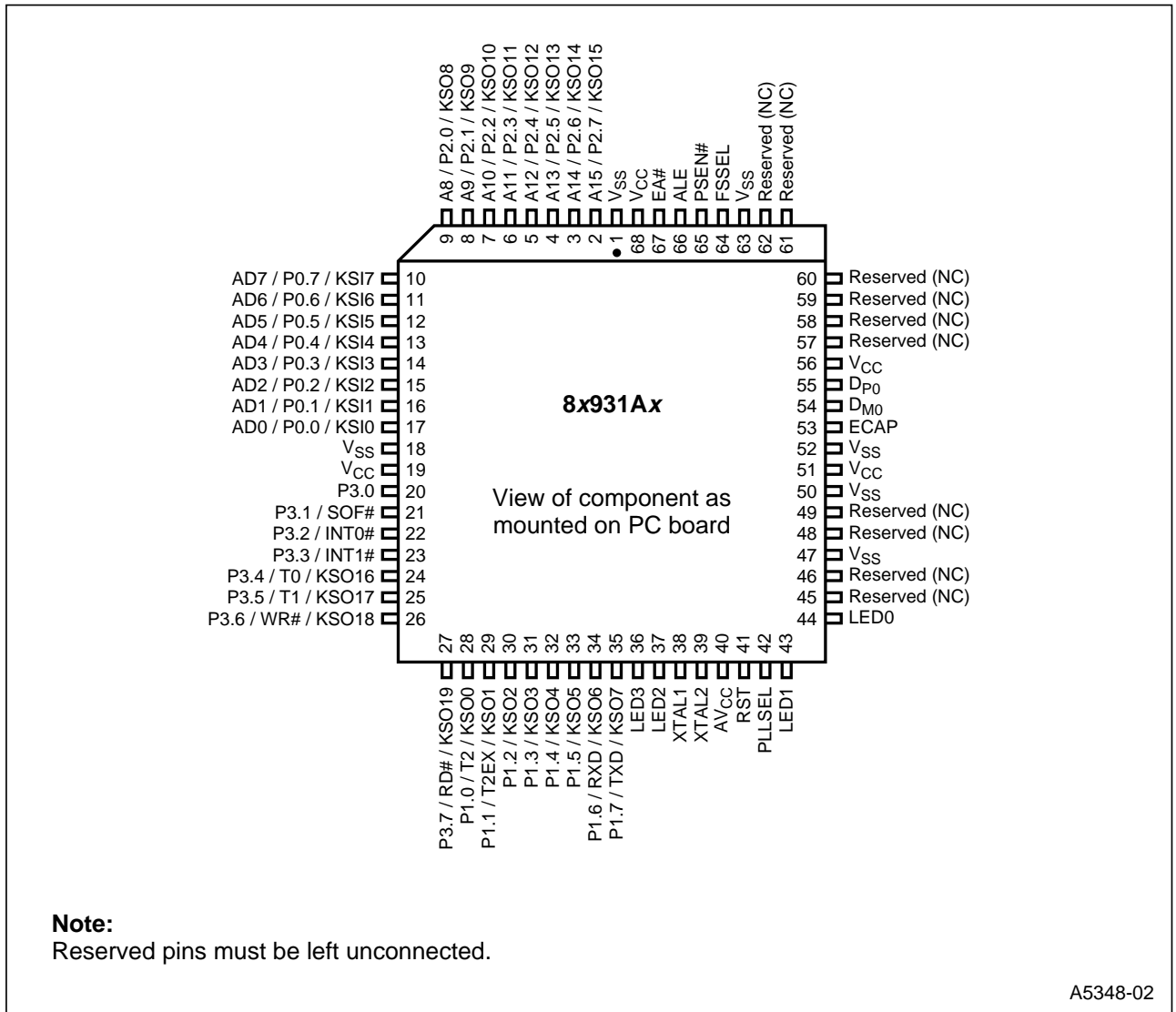


Figure 5. 8x931AA 68-pin PLCC Package

Table 6. 68-pin PLCC Pin Assignment

Pin	Name	Pin	Name	Pin	Name
1	V _{SS}	24	P3.4/T0/KSO16	47	V _{SS}
2	A15/P2.7/KSO15	25	P3.5/T1/KSO17	48	Reserved [†] / D _{M3} ^{††}
3	A14/P2.6/KSO14	26	P3.6/WR#/KSO18	49	Reserved [†] / D _{P3} ^{††}
4	A13/P2.5/KSO13	27	P3.7/RD#/KSO19	50	V _{SS}
5	A12/P2.4/KSO12	28	P1.0/T2/KSO0	51	V _{CC}
6	A11/P2.3/KSO11	29	P1.1/T2EX/KSO1	52	V _{SS}
7	A10/P2.2/KSO10	30	P1.2/KSO2	53	ECAP
8	A9/P2.1/KSO9	31	P1.3/KSO3	54	D _{M0}
9	A8/P2.0/KSO8	32	P1.4/KSO4	55	D _{P0}
10	AD7/P0.7/KSI7	33	P1.5/KSO5	56	V _{CC}
11	AD6/P0.6/KSI6	34	P1.6/KSO6/RXD	57	Reserved [†] / D _{M5} ^{††}
12	AD5/P0.5/KSI5	35	P1.7/KSO7/TXD	58	Reserved [†] / D _{P5} ^{††}
13	AD4/P0.4/KSI4	36	LED3	59	Reserved [†] / D _{M4} ^{††}
14	AD3/P0.3/KSI3	37	LED2	60	Reserved [†] / D _{P4} ^{††}
15	AD2/P0.2/KSI2	38	XTAL1	61	Reserved (NC)
16	AD1/P0.1/KSI1	39	XTAL2	62	Reserved (NC)
17	AD0/P0.0/KSI0	40	AV _{CC}	63	V _{SS}
18	V _{SS}	41	RST	64	FSSEL [†] / UPWEN# ^{††}
19	V _{CC}	42	PLLSEL	65	PSEN#
20	P3.0/ OVRI# ^{††}	43	LED1	66	ALE
21	P3.1/SOF#	44	LED0	67	EA#
22	P3.2/INT0#	45	Reserved [†] / D _{M2} ^{††}	68	V _{CC}
23	P3.3/INT1#	46	Reserved [†] / D _{P2} ^{††}		

[†] Specific to the 8x931AA

^{††} Specific to the 8x931HA

Table 7. 68-pin PLCC Signal Assignments Arranged by Functional Category

Address & Data		Input/Output		USB	
Name	Pin	Name	Pin	Name	Pin
A15/P2.7/KSO15	2	P1.0/T2/KSO0	28	PLLSEL	42
A14/P2.6/KSO14	3	P1.1/T2EX/KSO1	29	D _{M0}	54
A13/P2.5/KSO13	4	P1.2/KSO2	30	D _{P0}	55
A12/P2.4/KSO12	5	P1.3/KSO3	31	Reserved [†] / D _{M5} ^{††}	57
A11/P2.3/KSO11	6	P1.4/KSO4	32	Reserved [†] / D _{P5} ^{††}	58
A10/P2.2/KSO10	7	P1.5/KSO5	33	Reserved [†] / D _{M2} ^{††}	45
A9/P2.1/KSO9	8	P1.6/KSO6	34	Reserved [†] / D _{P2} ^{††}	46
A8/P2.0/KSO8	9	P1.7/KSO7	35	Reserved [†] / D _{M3} ^{††}	48
AD7/P0.7/KSI7	10	P3.0/ OVR _I # ^{††}	20	Reserved [†] / D _{P3} ^{††}	49
AD6/P0.6/KSI6	11	P3.1/SOF#	21	ECAP	53
AD5/P0.5/KSI5	12	P3.2/INT0#	22	Reserved [†] / D _{M4} ^{††}	59
AD4/P0.4/KSI4	13	P3.3/INT1#	23	Reserved [†] / D _{P4} ^{††}	60
AD3/P0.3/KSI3	14	P3.4/T0/KSO16	24	FSSEL [†] /UPWEN# ^{††}	64
AD2/P0.2/KSI2	15	P3.5/T1/KSO17	25	OVR _I # ^{††}	20
AD1/P0.1/KSI1	16	P3.6/WR#/KSO18	26		
AD0/P0.0/KSI0	17	P3.7/RD#/KSO19	27		

Processor Control		Power & Ground		Bus Control & Status	
Name	Pin	Name	Pin	Name	Pin
P3.2/INT0#	22	V _{CC}	19,51, 56,68	P3.6/WR#/KSO18	26
P3.3/INT1#	23	AV _{CC}	40	P3.7/RD#/KSO19	27
RST	41	V _{SS}	1,18, 47,50, 52,63	PSEN#	65
XTAL1	38			ALE	66
XTAL2	39			EA#	67

[†] Specific to the 8x931AA

^{††} Specific to the 8x931HA

4.0 SIGNALS
Table 8. Signal Description (Sheet 1 of 3)

Signal Name	Type	Description	Alternate Function
A15:8	O	Address Lines. Upper byte of external memory address.	P2.7:0/KS08:15
AD7:0	I/O	Address/Data Lines. Lower byte of external memory address multiplexed with data	P0.7:0/KSI0:7
ALE	O	Address Latch Enable. ALE signals the start of an external bus cycle and indicates that valid address information is available on lines A15:8 and AD7:0. An external latch can use ALE to demultiplex the address from the address/data bus.	—
AV _{CC}	PWR	Analog V_{CC}. A separate V _{CC} input for the phase-locked loop circuitry.	—
D _{M0} , D _{P0}	I/O	USB Port 0. Root port. Upstream port to the host PC. D _{P0} and D _{M0} are the differential data plus and data minus signals of USB port 0. These lines do not have internal pullup resistors. Provide an external 1.5 K Ω pullup resistor at D _{P0} so the device indicates to the host that it is a full-speed device; or provide an external 1.5 K Ω pullup resistor at D _{M0} so the device indicates to the host that it is a low-speed device. NOTE: D _{P0} low AND D _{M0} low signals an SE0 (USB reset), causing the 8x931 to stay in reset.	—
D _{M2} , D _{P2} D _{M3} , D _{P3} D _{M4} , D _{P4} D _{M5} , D _{P5}	I/O	USB External Downstream Ports 2, 3, 4,5. These pins are the differential data plus and data minus lines for the four USB external downstream ports. These lines do not have internal pulldown resistors. Provide an external 15 K Ω pulldown resistor at each of these pins. See “Design Considerations” on page 24.	—
EA#	I	External Access. Directs program memory accesses to on-chip or off-chip code memory. For EA# strapped to ground, all program memory accesses are off-chip. For EA# strapped to V _{CC} , program accesses on-chip ROM if the address is within the range of the on-chip ROM; otherwise the access is off-chip. The value of EA# is latched at reset. For devices without on-chip ROM, EA# must be strapped to ground.	—
ECAP	I	External Capacitor. Connect a 1 μ F or larger capacitor between this pin and V _{SS} to ensure proper operation of the differential line drivers. May be used to supply 3.0v to 3.6v for 1.5K pullup resistor connected to USB Port 0. See “Design Considerations” on page 24.	—
FSSEL		Full Speed Select. Applies to the 8x931AA only. If this pin is high, full speed USB data rate is selected (12Mbps). If pin is low, low speed USB data rate is selected (1.5 Mbps). Refer to Table 11.	—

Table 8. Signal Description (Sheet 2 of 3)

Signal Name	Type	Description	Alternate Function
INT1:0#	I	External Interrupts 0 and 1. These inputs set the IE1:0 interrupt flags in the TCON register. Bits IT1:0 in TCON select the triggering method: edge-triggered (high-to-low) or level triggered (active low). INT1:0 also serves as external run control for timer1:0 when selected by GATE1:0# in TCON.	P3.3:2
KSI7:0	I	Keyboard Scan Input. Schmitt-trigger inputs with firmware-enabled internal pullup resistors used for the input side of the keyboard scan matrix.	AD7:0/P0.7:0
KSO19 KSO18 KSO17:16 KSO15:8 KSO7:0	O	Keyboard Scan Output. Quasi-bidirectional ports with weak internal pullup resistors used for the output side of the keyboard scan matrix.	P3.7/RD# P3.6/WR# P3.5:4/T1:0 A15:8/P2.7:0 P1.7:0
LED3:0	O	LED Drivers. Designed to drive LEDs connected directly to V_{CC} . The current each driver is capable of sinking is given as V_{OL2} in the datasheet.	—
OVRI#	I	Overcurrent Sense. Sense input to indicate an overcurrent condition on an external down-stream port. Active low with an internal pullup.	P3.0
P0.7:0	I/O	Port 0. Eight-bit, open-drain, bidirectional I/O port. Port 0 pins have Schmitt trigger inputs.	AD7:0/KSI7:0
P1.7:0	I/O	Port 1. Eight-bit quasi-bidirectional I/O port with internal pullups.	KSO7:0
P2.7:0	I/O	Port 2. Eight-bit quasi-bidirectional I/O port with internal pullups.	A15:8/KSO15:8
P3.0 P3.1 P3.2 P3.3 P3.4 P3.5 P3.6 P3.7	I/O	Port 3. Eight-bit quasi-bidirectional I/O port with internal pullups.	OVRI# SOF# INT0# INT1# T0/KSO16 T1/KSO17 WR#/KSO18 RD#/KSO19
PLLSEL	I	Phase-locked Loop Select. For normal operation using the 8x931HA, connect PLLSEL to logic high. PLLSEL = 0 is used for factory test only. (See Table 10). For 8x931AA operation, see Table 11.	—
PSEN#	O	Program Store Enable. Read signal output. Asserted for read accesses to external program memory.	—
RD#	O	Read. Read signal output. Asserted for read accesses to external data memory.	P3.7/KSO19
RXD	I/O	Receive Serial Data. RXD sends and receives data in serial I/O mode 0 and receives data in serial I/O modes 1, 2, and 3.	P1.6

Table 8. Signal Description (Sheet 3 of 3)

Signal Name	Type	Description	Alternate Function
RST	I	Reset. Reset input to the chip. Holding this pin high for two machine cycles while the oscillator is running resets the device. The port pins are driven to their reset conditions when a voltage greater than V_{IH1} is applied, whether or not the oscillator is running. This pin has an internal pulldown resistor which allows the device to be reset by connecting a capacitor between this pin and V_{CC} . Asserting RST when the chip is in idle mode or powerdown mode returns the chip to normal operation.	—
SOF#	O	Start of Frame. Start of frame pulse. Active low. Asserted for 8 states when frame timer is locked to USB frame timing and SOF token or artificial SOF is detected.	P3.1
T1:0	I	Timer 1:0 External Clock Input. When timer 1:0 operates as a counter, a falling edge on the T1:0 pin increments the count.	P3.5:4/KSO17:16
T2	I/O	Timer 2 Clock Input/Output. For the timer 2 capture mode, this signal is the external clock input. For the clock-out mode, it is the timer 2 clock output.	P1.0
T2EX	I	Timer 2 External Input. In timer 2 capture mode, a falling edge initiates a capture of the timer 2 registers. In auto-reload mode, a falling edge causes the timer 2 registers to be reloaded. In the up-down counter mode, this signal determines the count direction: 1 = up, 0 = down.	P1.1
TXD	O	Transmit Serial Data. TXD outputs the shift clock in serial I/O mode 0 and transmits serial data in serial I/O modes 1, 2, and 3.	P1.7
UPWEN#	O	USB Power Enable. A low signal on this pin applies power to the external downstream ports.	—
V_{CC}	PWR	Supply Voltage. Connect this pin to the +5v supply voltage. Use a 0.1 μ f decoupling capacitor for each V_{CC} pin.	—
V_{SS}	GND	Circuit Ground. Connect this pin to ground.	—
WR#	O	Write. Write signal output to external memory.	P3.6/KSO19
XTAL1	I	Oscillator Amplifier Input. When implementing the on-chip oscillator, connect the external crystal or ceramic resonator across XTAL1 and XTAL2. If an external clock source is used, connect it to this pin.	—
XTAL2	O	Oscillator Amplifier Output. When implementing the on-chip oscillator, connect the external crystal or ceramic resonator across XTAL1 and XTAL2. If an external oscillator is used, leave XTAL2 unconnected.	—

5.0 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS[†]

Ambient Temperature Under Bias.....	-40°C to +85°C
Storage Temperature	-65°C to +150°C
Voltage on Any Pins to V _{SS}	-0.5 V to +6.5 V
I _{OL} per I/O Pin	15 mA
Power Dissipation (1)	1.5 W

NOTICE: This document contains information on products in the sampling and initial production phases of development. The specifications are subject to change without notice. Verify with your local Intel sales office that you have the latest datasheet before finalizing a design.

OPERATING CONDITIONS[†]

T _A (Ambient Temperature Under Bias):	
Commercial	-0°C to +70°C
V _{CC} (Digital Supply Voltage)	4.40 V to 5.25 V
V _{SS}	0 V
AV _{CC} (Analog Supply Voltage)	4.40 V to 5.25 V
F _{OSC}	12 MHz

[†] **WARNING: Stressing the device beyond the “Absolute Maximum Ratings” may cause permanent damage. These are stress ratings only. Operation beyond the “Operating Conditions” is not recommended and extended exposure beyond the “Operating Conditions” may affect device reliability.**

NOTE:

1. Maximum power dissipation is based on package heat-transfer limitations, not device power consumption.

Table 9. 8x931AA/8x931HA Supply Voltages

Parameter	Condition	Symbol	Min	Max
Supply Voltage		8x931HA V _{CC} /V _{bus}	4.40V	5.25V
		8x931AA V _{CC} /V _{bus}	4.15V [†]	5.25V

[†]For bus-powered device, voltage droop during hot plug may cause the supply voltage to drop to 4V worst case. The functionality of the device is supported at this voltage.

5.1 Operating Frequencies

Table 10. 8x931HA Operating Frequency

PLLSEL	XTAL1 Frequency (F _{osc})	USB Rate (1)	Internal Frequency (F _{CLK}) (2)	XTAL1 Clocks per State (T _{osc} /state) (3)	Comments
0 (4)	–	–	–	–	–
1	12 MHz	12 Mbps (Full Speed)	6 MHz (3)	2	PLL On

NOTES:

1. The sampling rate is 4 times the USB rate.
2. The internal frequency, $F_{CLK} = 1/T_{CLK}$, is the clock signal distributed to the CPU and the on-chip peripherals,
3. Following device reset, the CPU and on-chip peripherals operate in low-clock mode ($F_{CLK} = 3$ MHz) until the LC bit in the PCON register is cleared. In low clock mode, there are four T_{OSC} periods per state. Low-clock mode does not affect the USB rate.
4. PLLSEL = 0 is used during factory test only.

Table 11. 8x931AA Operating Frequencies

PLLSEL Pin	FSSEL Pin	LC Bit (1)	XTAL1 Frequency (MHz)	USB Rate (FS/LS) (2)	Core Frequency F _{CLK} (Mhz)	Comment
0	0	0	6	LS	3	PLL Off
0	0	1	6	LS	3	PLL Off
1	0	0	12	LS	6	PLL Off
1	0	1	12	LS	3	PLL Off
1	1	0	12	FS	6	PLL On
1	1	1	12	FS	3	PLL On

NOTES:

1. Reset and power up routines set the LC bit in PCON to put the 8x931AA in low-clock mode (core frequency = 3 MHz) for lower I_{CC} prior to device enumeration. Following completion of device enumeration, firmware should clear the LC bit to exit the low-clock mode. The user may switch the core frequency back and forth at any time, as needed.
2. USB rates: Low speed = 1.5 Mbps; Full speed = 12 Mbps. The USB sample rate is 4X the USB rate.

5.2 DC Characteristics

Table 12. DC Characteristics at Operating Conditions

Symbol	Parameter	Min	Typical (1)	Max	Units	Test Conditions
V_{IL}	Input Low Voltage (except EA#)	-0.5		$0.2 V_{CC} - 0.1$	V	
V_{IL1}	Input Low Voltage (EA#)	0		$0.2 V_{CC} - 0.3$	V	
V_{IH}	Input High Voltage (except XTAL1, RST)	$0.2 V_{CC} + 0.9$		$V_{CC} + 0.5$	V	
V_{IH1}	Input High Voltage (XTAL1, RST)	$0.7 V_{CC}$		$V_{CC} + 0.5$	V	
V_{OL}	Output Low Voltage (port 1, 2, 3) (2)			0.3 0.45 1.0	V	$I_{OL} = 100 \mu A$ $I_{OL} = 1.6 mA$ $I_{OL} = 3.5 mA$
V_{OL1}	Output Low Voltage (port 0, ALE, PSEN#, SOF#) (2)			0.3 0.45 1.0	V	$I_{OL} = 200 \mu A$ $I_{OL} = 3.2 mA$ $I_{OL} = 7.0 mA$
V_{OL2}	Output Low Voltage (LED 0, 1, 2, 3)			2.0 3.0	V	$I_{OL} = 6 mA$ $I_{OL} = 22 mA$
V_{OH}	Output High Voltage (port 1, 2, 3, ALE, PSEN#, SOF#) (3)	$V_{CC} - 0.3$ $V_{CC} - 0.7$ $V_{CC} - 1.5$			V	$I_{OH} = -10 \mu A$ $I_{OH} = -30 \mu A$ $I_{OH} = -60 \mu A$
V_{OH1}	Output High Voltage (port 0 in external address space) (3)	$V_{CC} - 0.3$ $V_{CC} - 0.7$ $V_{CC} - 1.5$			V	$I_{OH} = -200 \mu A$ $I_{OH} = -3.2 mA$ $I_{OH} = -7.0 mA$
I_{IL}	Logical 0 Input Current (port 1,2,3)			-50	μA	$V_{IN} = 0.45 V$
I_{LI}	Input Leakage Current (port 0)			± 10	μA	$V_{IN} = V_{IL} \text{ or } V_{IH}$

NOTE:

- Typical values are obtained using $V_{CC} = 5.0V$, $T_A = 25^\circ C$ and are not guaranteed.
- Capacitive loading on ports 0 and 2 may cause spurious noise pulses above 0.4 V on the low-level outputs of ALE and ports 1, 2 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins change from 1 to 0. In applications where capacitive loading exceeds 100 pF, the noise pulses on these signals may exceed 0.8 V. It may be desirable to qualify ALE or other signals with a Schmitt trigger or CMOS-level input logic.
- Capacitive loading on ports 0 and 2 causes the V_{OH} on ALE and PSEN to drop below the V_{CC} specification when the address lines are stabilizing.

Table 12. DC Characteristics at Operating Conditions (Continued)

Symbol	Parameter	Min	Typical (1)	Max	Units	Test Conditions
I_{TL}	Logical 1-to-0 Transition Current (Port 1, 2,3)			-650	μA	$V_{IN} = 2.0 V$
R_{RST}	RST Pulldown Resistor	40		100	$K\Omega$	
C_{IO}	Pin Capacitance		10		μF	$F_{OSC} = 12 MHz$ $T_A = 25^\circ C$
I_{PD}	Powerdown Current USB suspend		145	175	μA	
I_{DL}	Idle Mode I_{CC}			40	mA	$F_{CLK} = 6 MHz$
				30		$F_{CLK} = 3 MHz$
I_{CC}	Active I_{CC}			70	mA	$F_{CLK} = 6 MHz$
				50		$F_{CLK} = 3 MHz$
U_{ZDRV}	USB Drivers Output	10		25	$K\Omega$	

NOTE:

1. Typical values are obtained using $V_{CC} = 5.0V$, $T_A = 25^\circ C$ and are not guaranteed.
2. Capacitive loading on ports 0 and 2 may cause spurious noise pulses above 0.4 V on the low-level outputs of ALE and ports 1, 2 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins change from 1 to 0. In applications where capacitive loading exceeds 100 pF, the noise pulses on these signals may exceed 0.8 V. It may be desirable to qualify ALE or other signals with a Schmitt trigger or CMOS-level input logic.
3. Capacitive loading on ports 0 and 2 causes the V_{OH} on ALE and PSEN to drop below the V_{CC} specification when the address lines are stabilizing.

5.3 Explanation of Timing Symbols

Table 13 defines the timing symbols used in Tables 14 through 16 and the associated timing diagrams. They have the form T_{XYY} , where the character pairs represent a signal and its condition. Timing symbols represent the time between two signal / condition points.

Table 13. AC Timing Symbol Definitions

Symbol	Definition
A	Address: A15:8, A7:0
C	External Clock (XTAL1)
D	Data In: D7:0
L	ALE: Address Latch Enable
P	Program Store Enable (PSEN#)
Q	Data Out: D7:0
R	Read: RD#
W	Write: WR#

Character	Condition
H	High
L	Low
V	Valid, Setup
X	No Longer Valid, Hold
Z	Floating (low impedance)

5.4 System Bus AC Characteristics

Test Conditions: $F_{OSC} = 12$ MHz. Rise and fall times = 10 ns. Capacitive loading on ALE, PSEN#, and port P0 = 100 pF. Capacitive loading on all other outputs = 80 pF.

Table 14. External Bus Characteristics

Symbol	Parameter	$F_{OSC} = 12$ MHz, $F_{CLK} = 6$ MHz		Variable F_{CLK}		Units
		Min	Max	Min	Max	
F_{OSC}	XTAL1 Frequency	12 ± 0.25%				MHz
T_{CLK}	1/ $F_{CLK} = 1$ /CPU Frequency	166.67 (Typical)				ns
T_{LHLL}	ALE Pulse Width	127		$T_{CLK} - 40$		ns
T_{AVLL}	Address Valid to ALE Low	43		$0.5T_{CLK} - 40$		ns
T_{LLAX}	Address Hold after ALE Low	53		$0.5T_{CLK} - 30$		ns
T_{PLAZ}	PSEN# Low to Address Float		10		10	ns
T_{LLIV}	ALE Low to Instruction In Valid		259		$2T_{CLK} - 75$	ns
T_{LLPL}	ALE Low to PSEN# Low	53		$0.5T_{CLK} - 30$		ns
T_{PLPH}	PSEN# Pulse Width	205		$1.5T_{CLK} - 45$		ns
T_{PLIV}	PSEN# Low to Instruction In Valid		77		$T_{CLK} - 90$	ns
T_{PHIX}	Instruction Hold after PSEN# High	0		0		ns
T_{PHIZ}	Instruction Float after PSEN# High		63		$0.5T_{CLK} - 20$	ns
T_{AVIV}	Address Valid to Instruction Valid		312		$2.5T_{CLK} - 105$	ns
T_{LLRL}, T_{LLWL}	ALE Low to RD# or WR# Low	200	300	$1.5T_{CLK} - 50$	$1.5T_{CLK} + 50$	ns
T_{RLRH}, T_{WLWH}	RD# and WR# Pulse Width	400		$3T_{CLK} - 100$		ns
T_{LLDV}	ALE Low to Data In Valid		578		$4T_{CLK} - 90$	ns
T_{RLDV}	RD# Low to Data In Valid		322		$2.5T_{CLK} - 95$	ns
T_{RLAZ}	RD# Low to Address Float		0		0	ns
T_{RHDX}	Data Hold After RD# High	0		0		ns
T_{RHDZ}	Data Float After RD# High		23		$0.5T_{CLK} - 60$	ns
T_{AVRL}, T_{AVWL}	Address Valid to RD# or WR# Low	244		$2T_{CLK} - 90$		ns

Table 14. External Bus Characteristics (Continued)

Symbol	Parameter	$F_{OSC} = 12\text{ MHz},$ $F_{CLK} = 6\text{ MHz}$		Variable F_{CLK}		Units
		Min	Max	Min	Max	
T_{AVDV}	Address Valid to Data In Valid		661		$4.5T_{CLK} - 90$	ns
T_{RHLH}, T_{WHLH}	RD# or WR# High to ALE High	43	123	$0.5T_{CLK} - 40$	$0.5T_{CLK} + 40$	ns
T_{QVWX}	Data Valid to WR# Transition	48		$0.5T_{CLK} - 35$		ns
T_{QVWH}	Data Valid to WR# High	514		$3.5T_{CLK} - 70$		ns
T_{WHQX}	Data Hold After WR# High	43		$0.5T_{CLK} - 40$		ns

5.4.1 System Bus Timing Diagrams

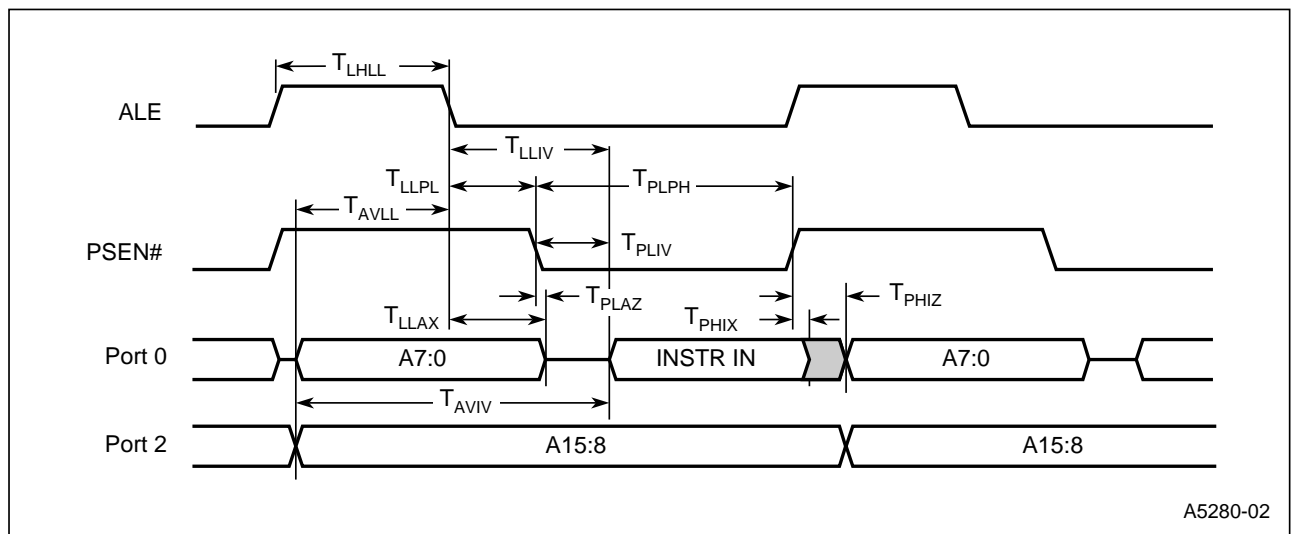


Figure 6. 8x931AA/HA External Program Memory Read

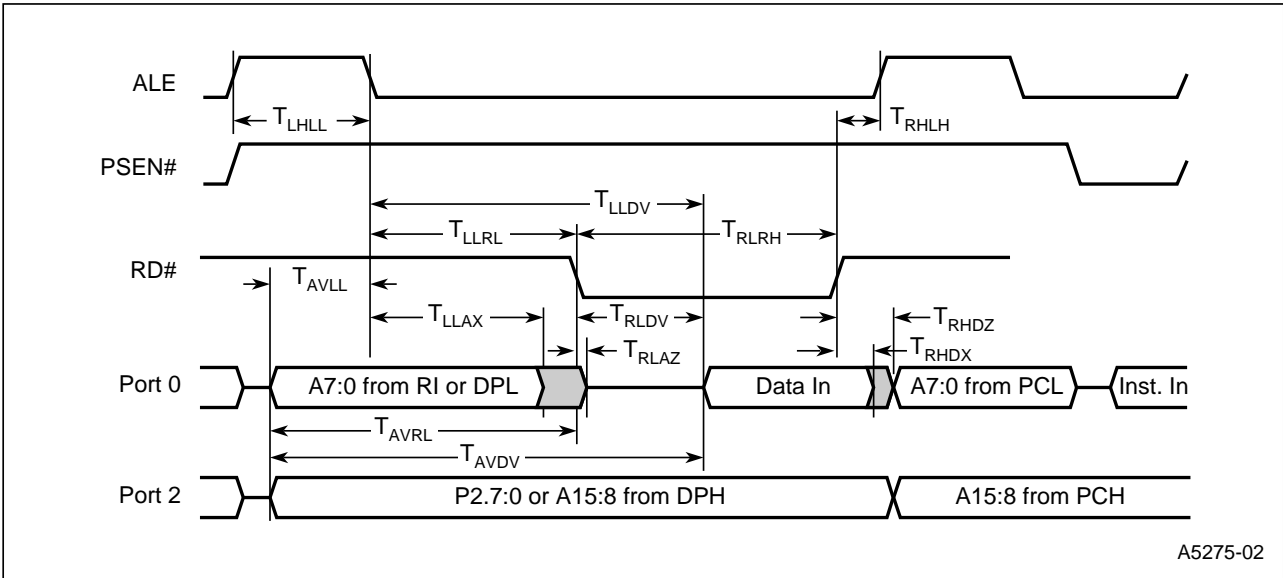


Figure 7. 8x931AA/HA External Data Memory Read

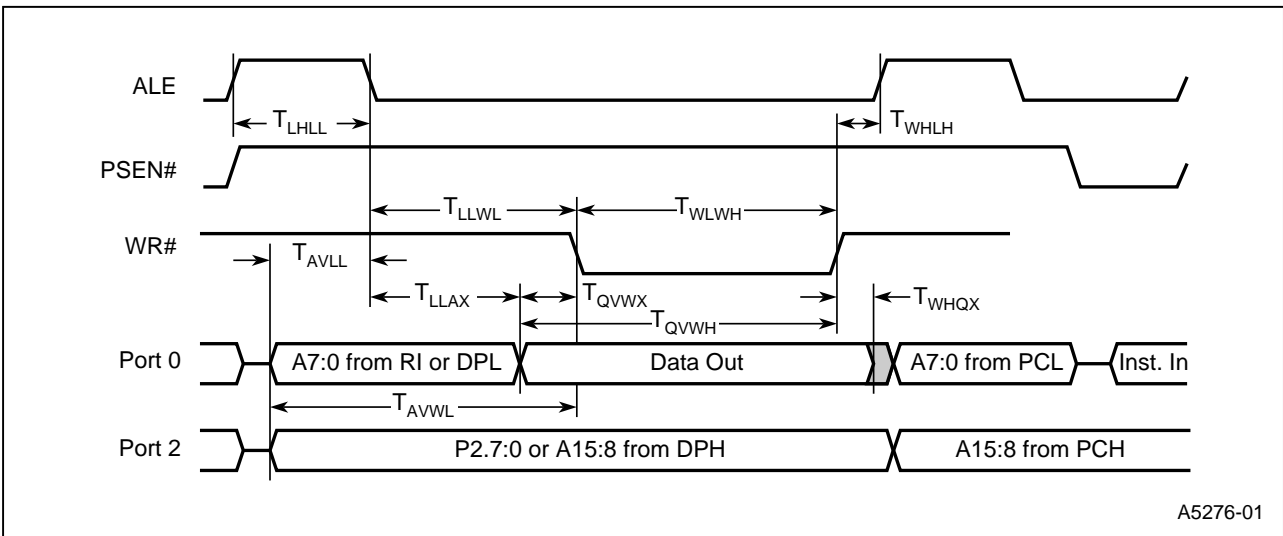


Figure 8. 8x931AA/HA External Data Memory Write

5.5 AC Characteristics — Synchronous Mode 0

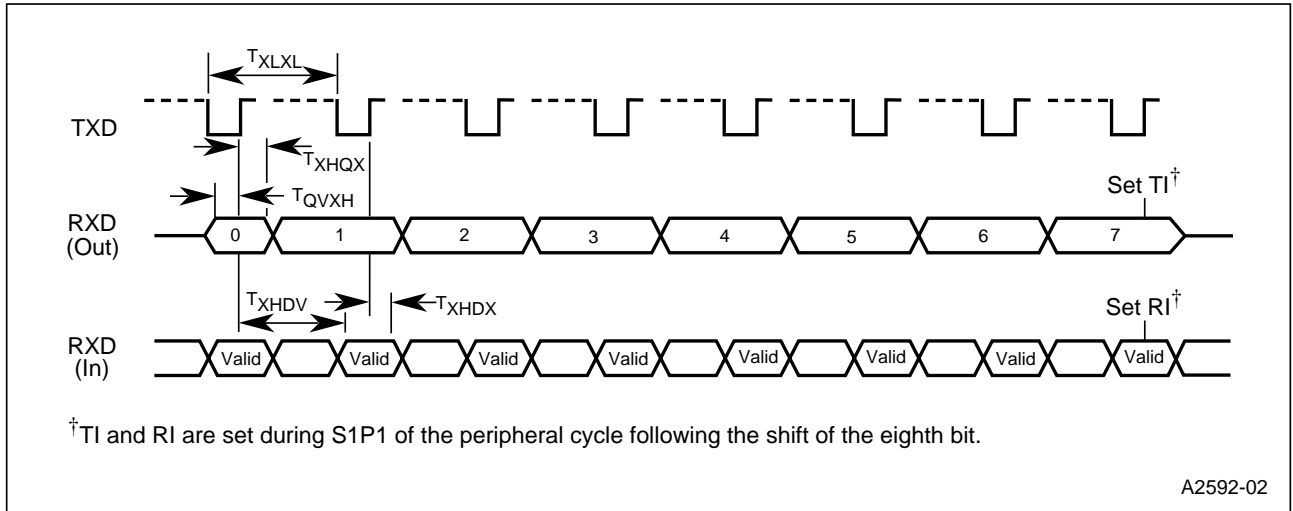


Figure 9. Serial Port Waveform — Synchronous Mode 0

Table 15. Serial Port Timing — Synchronous Mode 0

Symbol	Parameter	Min	Max	Units
T_{XLXL}	Serial Port Clock Cycle Time	$12 T_{OSC}$		ns
T_{QVXH}	Output Data Setup to Clock Rising Edge	$10 T_{OSC} - 133$		ns
T_{XHQX}	Output Data Hold after Clock Rising Edge	$2 T_{OSC} - 50$		ns
T_{XHDX}	Input Data Hold after Clock Rising Edge	0		ns
T_{XHDV}	Clock Rising Edge to Input Data Valid		$10 T_{OSC} - 133$	ns

5.6 External Clock Drive

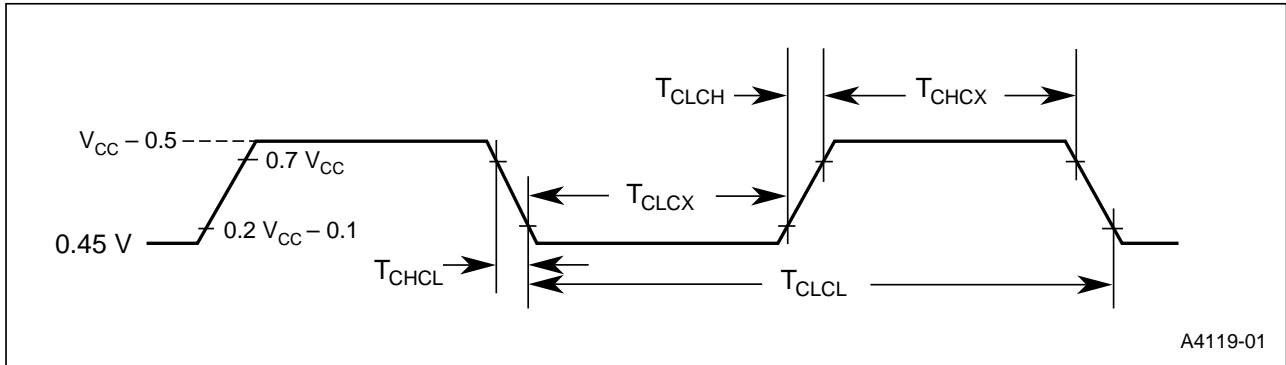


Figure 10. External Clock Drive Waveforms

Table 16. External Clock Drive

Symbol	Parameter	Min	Max	Units
$1/T_{OSC}$	Oscillator Frequency (F_{OSC})	6	12	MHz
T_{CHCX}	High Time	20		ns
T_{CLCX}	Low Time	20		ns
T_{CLCH}	Rise Time		20	ns
T_{CHCL}	Fall Time		20	ns

5.7 Testing Waveforms

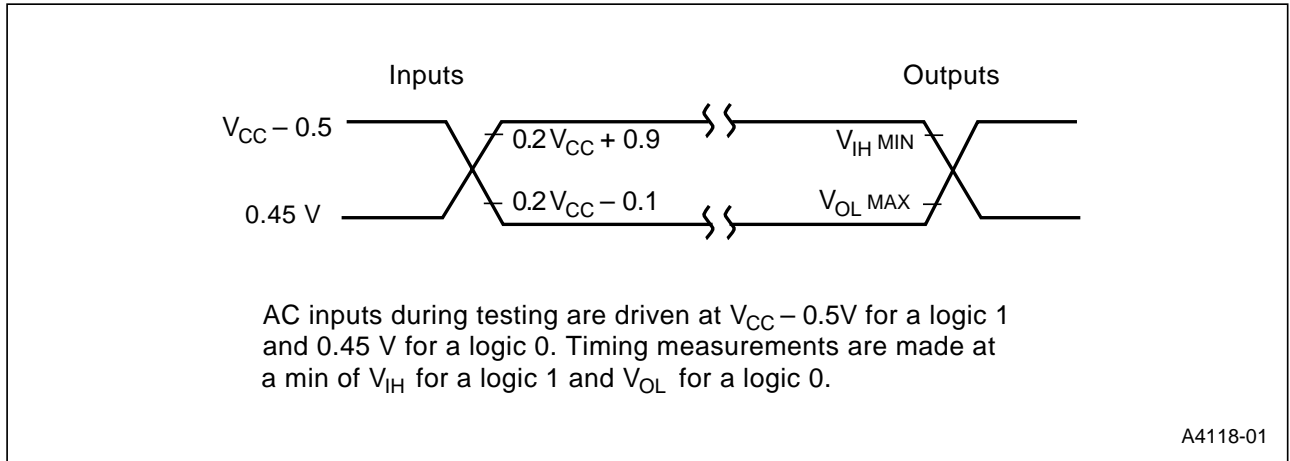


Figure 11. AC Testing Input, Output Waveforms

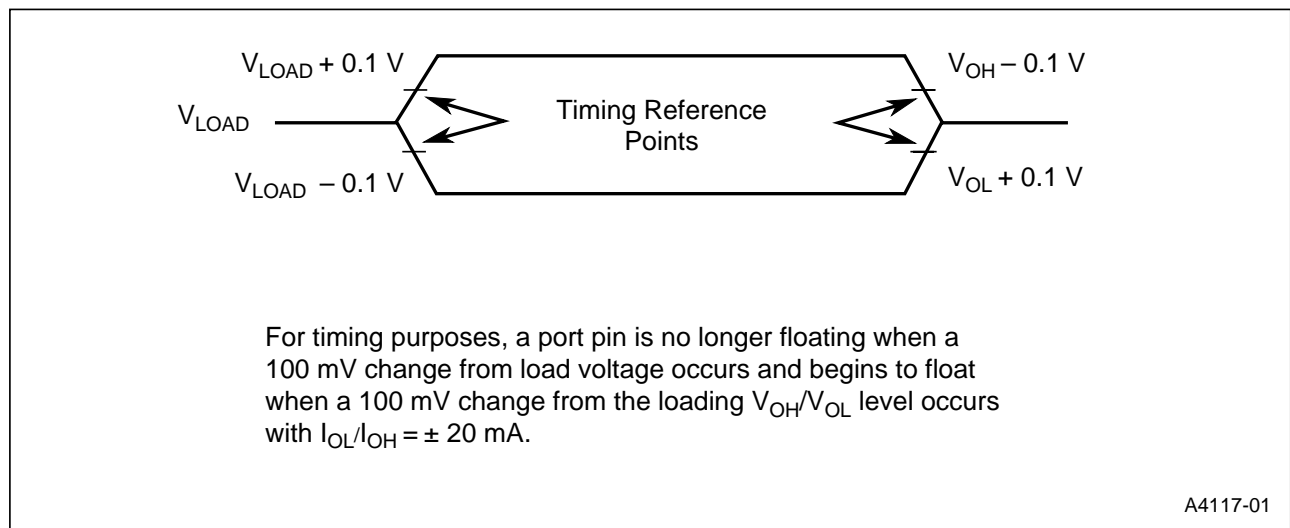


Figure 12. Float Waveforms

6.0 THERMAL CHARACTERISTICS

The microcontroller operates over the commercial temperature range from 0°C to 70°C. All thermal impedance data (see Table 17) is approximate for static air conditions at 1 watt of power dissipation. Values change depending on operating conditions and application requirements. The Intel *Packaging Handbook* (order number 240800) describes Intel's thermal impedance test methodology. The *Components Quality and Reliability Handbook* (order number 210997) provides quality and reliability information.

Table 17. Thermal Characteristics

Package Type	θ_{JA}^\dagger	θ_{JC}^\dagger
68-pin PLCC	N/A	N/A

[†] Data unavailable at time of publication.

7.0 DESIGN CONSIDERATIONS

7.1 Low Clock Mode Frequency

During low clock mode, the internal clock F_{CLK} distributed to the CPU and peripherals is 3 MHz. Peripheral timing and external bus accesses (including instruction fetch and data read/write) are affected. Refer to Table 10 and Table 11 for clock rates.

7.2 Setting RXFFRC Bit Clears Only the Oldest Packet in the FIFO

If the receive FIFO is set as a dual packet mode, then it can receive two packets. Setting RXFFRC (in RXCON registers) to indicate FIFO Read Complete will **not** flush the entire FIFO; it will flush only the oldest packet. The read marker will be advanced to the location of the read pointer.

7.3 Series Resistor Requirement for Impedance Matching

Per USB rev. 1.0 specification (page 111, section 7.1.1.1), the impedance of the differential driver must be between 29Ω and 44Ω. To match the cable impedance, a series resistor of 27Ω to 33Ω should be connected to each USB line; i.e., on D_{P0} and on D_{M0} . If the USB line is improperly terminated or not matched, then signal fidelity will suffer. This

condition can be seen on the oscilloscopes as excessive overshoot and undershoot. This condition can potentially introduce bit errors.

7.4 Pullup Resistor Requirement for 8x931AA/HA devices

The USB specification requires a pullup resistor to allow the host to identify which devices are low speed and which are full speed in order to communicate at the appropriate data rate. For 8x931HA hub devices (12 Mbps), use a 1.5KΩ pullup resistor (to 3.0 V – 3.6 V; may use the ECAP pin.) on the D_{P0} line. 8x931AA devices can be either full speed or low speed; add a 1.5KΩ pullup to the appropriate USB line.

7.5 Powerdown Mode Cannot Be Invoked Before USB Suspend

If the 8x931AA/HA is put into powerdown mode before receiving a USB suspend signal from the host, then a USB resume will not properly wake up the 8x931AA/HA from powerdown mode.

7.6 Unused Downstream Ports

If the USB downstream ports are not used, it is still required that the two data lines be pulled low externally (similar to a disconnect) so that the inputs are not floating. This will eliminate the possibility of induced system noise. All USB data lines require 15KΩ external pulldown resistors. Do **not** leave unused port(s) disconnected.

7.7 ECAP Usage to Supply 3.0 to 3.6 Volts for 1.5K Ohm Pullup

For a self-powered or bus-powered device, when the voltage at the V_{CC} pins are at 5.25v, the voltage at ECAP pin will be at approximately 3.6v. If the V_{CC} pin is at 4.65v [Min, Vbus Powered (host or hub) Port specification], the voltage at the ECAP pin will be at approximately 3.2v (refer to Table 18 below). The capability for this pin to supply the 3.0v to 3.6v voltage to the 1.5KΩ USB pullup terminator depends upon the V_{CC} voltage level.



For a bus-powered device that is connected to a bus-powered hub, when the voltage at the V_{CC} pins (in the bus-powered devices) are at 4.28v, the voltage at ECAP pin will be at approximately 3.0v. If the V_{CC} voltage drops below 4.28v, the ECAP pin can not supply voltage above 3.0 v for the 1.5K Ω USB pullup terminator.

NOTE: *The typical ECAP values, listed in the table below, reflect a 1 μ F capacitor connection between the ECAP pin and ground.*

Table 18. V_{CC} and Typical ECAP Voltages

V _{CC}	ECAP Pin
5.25v	3.6v
5.00v	3.5v
4.65v	3.2v
4.40v	3.1v
4.28v	3.0v

8.0 8x931AA/HA ERRATA

The 8x931AA/HA may contain design defects or errors known as errata. Characterized errata that may cause the 8x931AA/HA's operational behavior to deviate from published specifications are documented in a specification update. Specification updates can be obtained from your local Intel sales office or from the World Wide Web (www.intel.com).

9.0 DATASHEET REVISION HISTORY

Datasheets are changed as new device information becomes available. Verify with your local Intel sales office that you have the latest version before finalizing a design or ordering devices.

This is the original version of the datasheet.

